

FDD8586/FDU8586 N-Channel PowerTrench<sup>®</sup> MOSFET

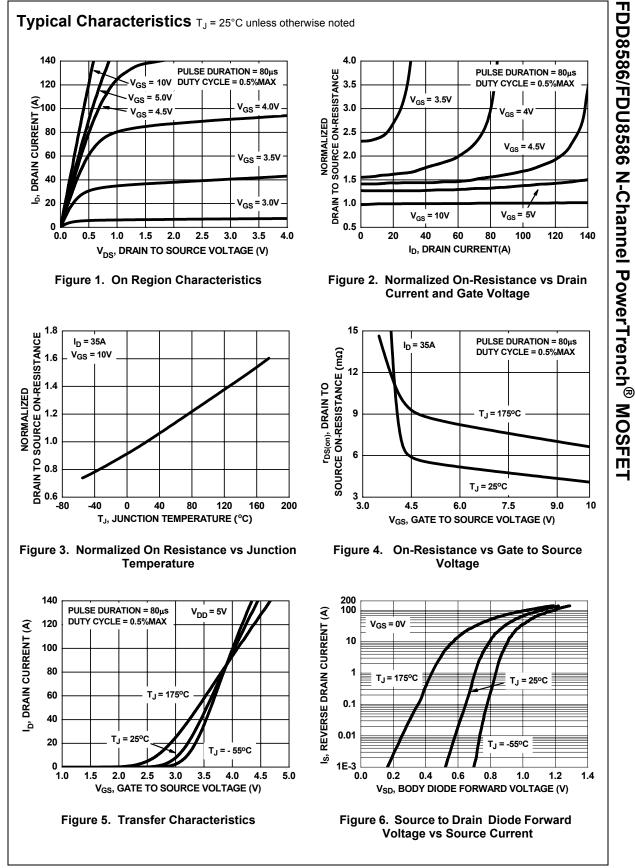
Symbol	Parameter		Ratings	Units
V <sub>DS</sub>	Drain to Source Voltage		20	V
V <sub>GS</sub>	Gate to Source Voltage		±20	V
	Drain Current -Continuous (Package Limited)		35	
I <sub>D</sub>	-Continuous (Die Limited)		93	А
	-Pulsed	(Note 1)	354	
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 2)	144	mJ
P <sub>D</sub>	Power Dissipation		77	W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature		-55 to 175	°C
Therma	I Characteristics			
R <sub>0JC</sub>	HJC Thermal Resistance, Junction to Case TO-252, TO-251		1.94	°C/W
D	The second Designment of the state Analytics of TO 050 TO 054		100	0000

Thermal Resistance, Junction to Ambient TO-252, TO-251 100 °C/W  $R_{\theta JA}$ Thermal Resistance, Junction to Ambient TO-252,1in<sup>2</sup> copper pad area 52 °C/W  $R_{\theta JA}$ 

# Package Marking and Ordering Information

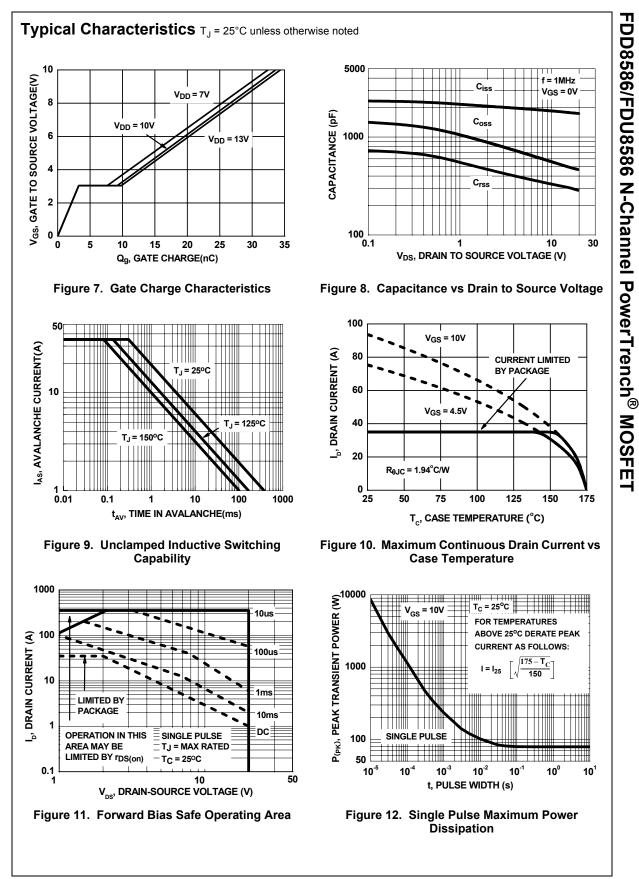
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD8586	FDD8586	TO-252AA	13"	12mm	2500 units
FDU8586	FDU8586	TO-251AA	N/A(Tube)	N/A	75 units

Drain to Source Breakdown Voltage         Breakdown Voltage Temperature         Coefficient         Zero Gate Voltage Drain Current         Gate to Source Leakage Current	$I_{D} = 250\mu A, V_{GS} = I_{D} = 250\mu A, refere25°CV_{DS} = 16V,V_{GS} = 0VV_{GS} = ±20V$		20	14.6		
Breakdown Voltage Temperature         Coefficient         Zero Gate Voltage Drain Current         Gate to Source Leakage Current	$I_D = 250\mu$ A, refere 25°C $V_{DS} = 16V$ , $V_{GS} = 0V$		20	14.6		
Breakdown Voltage Temperature         Coefficient         Zero Gate Voltage Drain Current         Gate to Source Leakage Current	$I_D = 250\mu$ A, refere 25°C $V_{DS} = 16V$ , $V_{GS} = 0V$			14.6		V
Coefficient Zero Gate Voltage Drain Current Gate to Source Leakage Current	25°C V <sub>DS</sub> = 16V, V <sub>GS</sub> = 0V			14.6		
Gate to Source Leakage Current	V <sub>GS</sub> = 0V					mV/°C
Gate to Source Leakage Current					1	μA
	$V_{GS} = \pm 20V$	5			250	_ μΑ
cteristics	6				±100	nA
Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D =$	2504	1.2	1.6	2.5	V
Gate to Source Threshold Voltage	$I_D = 250 \mu A$ , refer		1.2	1.0	2.5	v
Ũ	25°C			-6.7		mV/°C
- P	V <sub>GS</sub> = 10V, I <sub>D</sub> = 35A			4.0	5.5	mΩ
Drain to Source Or Desistance				5.7	8.5	
Drain to Source On Resistance	$V_{GS} = 10V, I_D = 35A$ $T_J = 175^{\circ}C$			6.5	8.9	
Forward Transcondductance	-			175		S
Input Capacitance Output Capacitance Reverse Transfer Capacitance	- V <sub>DS</sub> = 10V, V <sub>GS</sub> = f = 1MHz	= 0V,		1865 550 335	2480 730 445	pF pF pF
	f = 104117				445	Ω
<b>Characteristics</b> Turn-On Delay Time	T					
				0	10	20
,	V <sub>DD</sub> = 10V, I <sub>D</sub> = 3	35A		9	18	ns
Rise Time	V <sub>DD</sub> = 10V, I <sub>D</sub> = 3 V <sub>GS</sub> = 10V, R <sub>GS</sub>			11	20	ns
Rise Time Turn-Off Delay Time				11 47	20 75	ns ns
Rise Time Turn-Off Delay Time Fall Time	- V <sub>GS</sub> = 10V, R <sub>GS</sub>			11 47 25	20 75 40	ns ns ns
Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge at 10V	$V_{GS}$ = 10V, $R_{GS}$ V <sub>GS</sub> = 0V to 10V	= 10Ω V <sub>DD</sub> = 10V		11 47 25 34	20 75 40 48	ns ns ns nC
Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge at 10V         Total Gate Charge at 5V	- V <sub>GS</sub> = 10V, R <sub>GS</sub>	= 10Ω V <sub>DD</sub> = 10V I <sub>D</sub> = 35A		11 47 25 34 16	20 75 40	ns ns ns nC nC
Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge at 10V         Total Gate Charge at 5V         Gate to Source Gate Charge	$V_{GS}$ = 10V, $R_{GS}$ V <sub>GS</sub> = 0V to 10V	= 10Ω V <sub>DD</sub> = 10V		11 47 25 34 16 3.2	20 75 40 48	ns ns nC nC nC
Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge at 10V         Total Gate Charge at 5V         Gate to Source Gate Charge         Gate to Drain "Miller"Charge	$V_{GS}$ = 10V, $R_{GS}$ V <sub>GS</sub> = 0V to 10V	= 10Ω V <sub>DD</sub> = 10V I <sub>D</sub> = 35A		11 47 25 34 16	20 75 40 48	ns ns nS nC nC
Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge at 10V         Total Gate Charge at 5V         Gate to Source Gate Charge         Gate to Drain "Miller"Charge         urce Diode Characteristics	$V_{GS}$ = 10V, R <sub>GS</sub> $V_{GS}$ = 0V to 10V $V_{GS}$ = 0V to 5V	= 10Ω $V_{DD} = 10V$ $I_D = 35A$ $I_g = 1.0mA$		11 47 25 34 16 3.2 5.9	20 75 40 48 22	ns ns nC nC nC
Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge at 10V         Total Gate Charge at 5V         Gate to Source Gate Charge         Gate to Drain "Miller"Charge	$V_{GS} = 10V, R_{GS}$ $V_{GS} = 0V \text{ to } 10V$ $V_{GS} = 0V \text{ to } 5V$ $V_{GS} = 0V, I_S = 35$	$= 10\Omega$ $V_{DD} = 10V$ $I_{D} = 35A$ $I_{g} = 1.0mA$ $5A$		11 47 25 34 16 3.2	20 75 40 48 22 	ns ns nC nC nC
Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge at 10V         Total Gate Charge at 5V         Gate to Source Gate Charge         Gate to Drain "Miller"Charge         urce Diode Characteristics	$V_{GS}$ = 10V, R <sub>GS</sub> $V_{GS}$ = 0V to 10V $V_{GS}$ = 0V to 5V	$V_{DD} = 10V$ $V_{DD} = 35A$ $I_{g} = 1.0mA$ $SA$		11 47 25 34 16 3.2 5.9 0.89	20 75 40 48 22	ns ns nC nC nC
	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics	$\label{eq:constraint} \begin{array}{c} V_{GS} = 10V, \ I_D = 3\\ V_{GS} = 4.5V, \ I_D = 3\\ V_{GS} = 10V, \ I_D = 3\\ V_{GS} = 10V, \ I_D = 3\\ T_J = 175^\circ C\\ \end{array}$ Forward Transcondductance $V_{DS} = 10V, \ I_D = 3\\ \begin{array}{c} \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\$	$\begin{tabular}{ c c c c c } \hline V_{GS} &= 10V, \ I_D &= 35A \\ \hline V_{GS} &= 4.5V, \ I_D &= 33A \\ \hline V_{GS} &= 10V, \ I_D &= 35A \\ \hline T_J &= 175^\circ C \\ \hline Forward Transcondductance & V_{DS} &= 10V, \ I_D &= 35A \\ \hline \end{tabular}$	$\begin{tabular}{ c c c c c } \hline V_{GS} &= 10V, I_D &= 35A & & & \\ \hline V_{GS} &= 4.5V, I_D &= 33A & & \\ \hline V_{GS} &= 10V, I_D &= 35A & & \\ \hline V_{GS} &= 10V, I_D &= 35A & & \\ \hline T_J &= 175^\circ C & & & \\ \hline Forward Transcondductance & & V_{DS} &= 10V, I_D &= 35A & & \\ \hline \hline \hline \hline \hline \\ \hline \\ \hline \hline \\ \hline \hline \\ \hline \\ \hline \hline \hline \\ \hline \hline \\ \hline \hline \\ \hline \hline \\ \hline \hline \hline \hline \\ \hline \hline \hline \hline \\ \hline \hline \hline \hline \hline \\ \hline \hline \hline \hline \hline \hline \\ \hline \hline$	$\begin{tabular}{ c c c c c } \hline Temperature Coefficient & 25°C & & & & & & & & & & & & & & & & & & &$	$\begin{tabular}{ c c c c c c c } \hline Temperature Coefficient & 25°C & & & & 4.0 & 5.5 \\ \hline Temperature Coefficient & & V_{GS} = 10V, I_D = 35A & & 4.0 & 5.5 \\ \hline V_{GS} = 4.5V, I_D = 33A & & 5.7 & 8.5 \\ \hline V_{GS} = 10V, I_D = 35A & & 5.7 & 8.5 \\ \hline V_{GS} = 10V, I_D = 35A & & 6.5 & 8.9 \\ \hline Forward Transcondductance & V_{DS} = 10V, I_D = 35A & & 175 \\ \hline \end{tabular}$

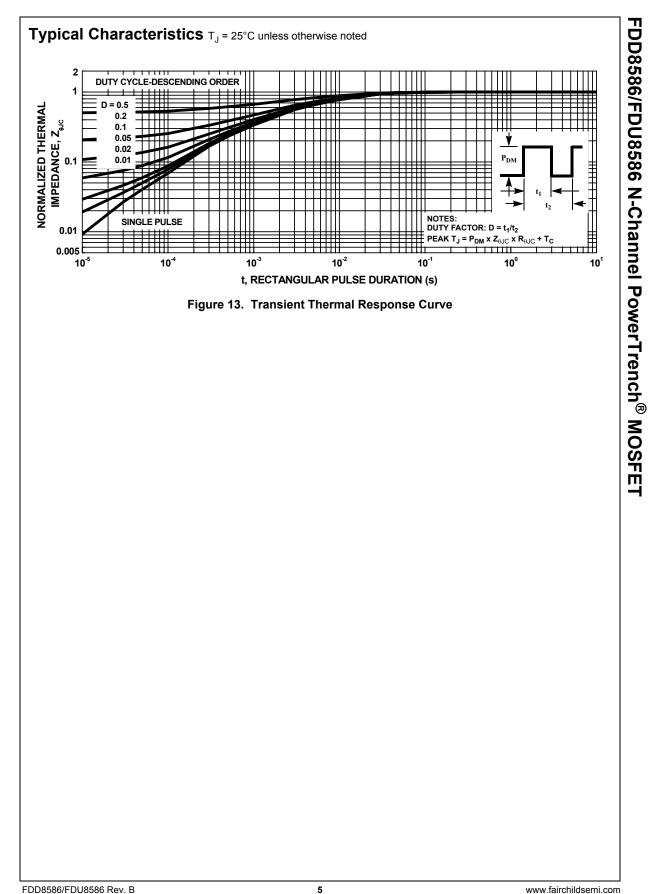


FDD8586/FDU8586 Rev. B

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